

WGM110 Wizard Gecko Wi-Fi® Module 数据表



Wizard Gecko WGM110 是一款全能型 Wi-Fi® 模块，可以满足应用程序对于卓越 RF 性能、低功耗、简易的应用开发以及快速上市时间的重要需求。WGM110 拥有出色的 RF 性能，可提供强大的远程无线连接。

WGM110 模块集成了 IoT Wi-Fi 应用程序所需的所有要素，包括 802.11b/g/n 无线电、集成芯片天线 (WGM110A) 或外部天线 u.FL 连接器 (WGM110E)、认证、微控制器、Wi-Fi 与 IP 协议栈、HTTP 服务器以及 TCP 与 UDP 等多种协议。

WGM110 可作为 Wi-Fi 客户端或 Wi-Fi 接入点使用，使得连接设备与上网一样简单。WGM110 可支持 BGScript™ 终端用户应用程序，这意味无需依赖外部微控制器即可设计应用程序。此外，Wi-Fi 模块可在网络协处理器 (NCP) 模式下运行，将复杂的 TCP/IP 网络问题留给模块来处理，从而确保客户自己的主机控制器可以完全用来处理客户应用程序的任务。WGM110 模块还具有高度灵活的硬件接口，可连接不同的外围设备或传感器。

除了 Wi-Fi 模块本身，Silicon Labs 还提供支持，指导并帮助开发人员使用 WGM110 来构建 IoT 应用程序，从而加快上市时间。

内容要点

- 模块版本
 - WGM110A (芯片天线)
 - WGM110E (u.FL 连接器)
- 支持 802.11b/g/n
- TX 功率: +16 dBm
- RX 灵敏度: -98 dBm
- 连接范围: 高达 450 m
- CPU 内核: 32 位 ARM® Cortex-M3
- 闪存: 1 MB
- RAM: 128 kB
- 模块验证
 - FCC
 - IC
 - 日本
 - 韩国
- 符合 CE 要求
- 端到端安全功能
- 可支持应用
- 小尺寸: 21.0 x 14.4 x 2.0 mm

WGM110 Module Block Diagram

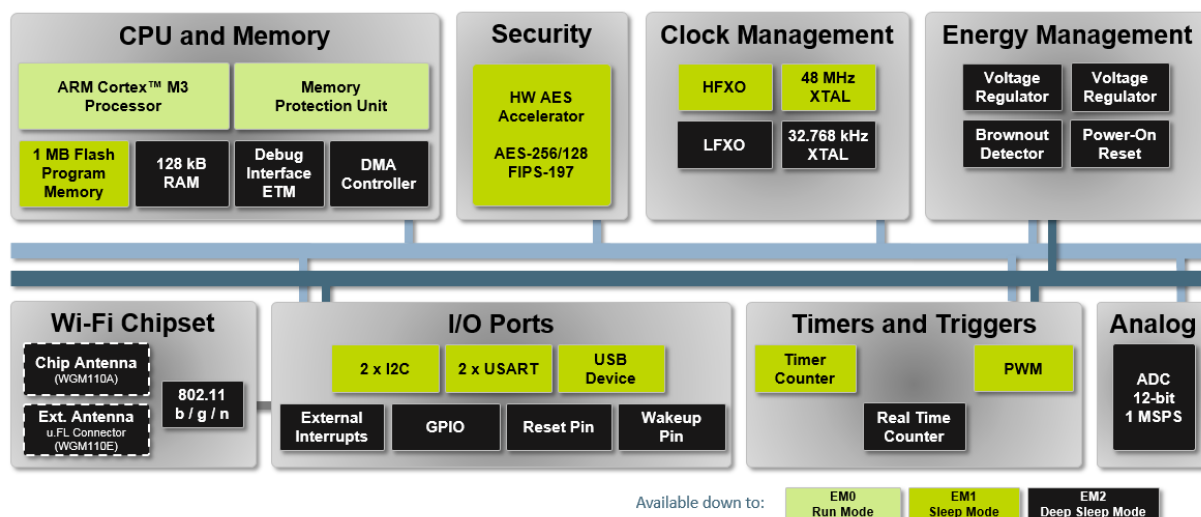


Table of Contents

1. Key Features	1
2. Pinout	2
2.1 Power, Ground and Reset Pads	2
2.2 Peripherals and GPIOs	3
2.2.1 Peripheral and GPIO Pads	3
2.2.2 Peripheral Locations	4
2.2.3 GPIO Port Pins	6
2.2.4 GPIO Input and Output Modes	6
2.2.5 Interrupt Pins	6
2.3 Debug and RF Test Pads	6
3. Interfaces	8
3.1 Host Interfaces	8
3.1.1 UART	8
3.1.2 SPI	11
3.1.3 USB	12
3.2 Peripheral Interfaces and Functions	12
3.2.1 USART (UART/SPI)	13
3.2.2 I ² C	13
3.2.3 Timer / PWM	13
3.2.4 Analog to Digital Converter (ADC)	13
3.3 Firmware Update and RF Test Interfaces	13
3.3.1 ARM Serial Wire Debug (SWD)	14
3.3.2 Device Firmware Upgrade (DFU)	14
3.3.3 RF Test Interface	14
3.3.4 Reference Schematic for SWD Debug and RF Test Interfaces	14
3.4 Real Time Counter (RTC)	14
4. Module Software	15
5. Hardware Design Guidelines	17
5.1 Power Supply Requirements	17
5.2 PCB Design Guidelines	17
5.3 Antenna Design Guidelines	18
5.3.1 Effect of Plastic and Metal Materials	18
5.3.2 Locating the Module Close to Human Body	19
6. Electrical Characteristics	20
6.1 Absolute Maximum Ratings	20
6.2 Recommended Operating Conditions	20
6.3 Input/Output Terminal Characteristics	20
6.4 Power-on Reset	21
6.5 Analog Digital Converter (ADC)	21

6.6 Power Consumption	.21
7. RF Characteristics	23
7.1 Supported Frequencies.	.23
7.2 Typical Receiver Sensitivity	.23
7.3 Transmitter Power at Maximum Setting	.23
7.4 Antenna Characteristics	.23
7.4.1 Typical Antenna Performance (WGM110A)	.24
7.4.2 Typical Radiation Pattern Plot (WGM110A)	.25
7.4.3 Qualified Antenna Types (WGM110E)	.26
8. Physical Dimensions and PCB Land Pattern	27
8.1 Module Top View Dimensions	.27
8.2 Module Side View Dimensions	.28
8.3 u.FL Connector Placement (WGM110E)	.29
8.4 Recommended Application PCB Land Pattern	.30
9. Soldering Recommendations	31
10. Tape and Reel Packaging	32
10.1 Tape Material and Dimensions	.32
10.2 Reel Material and Dimensions	.34
10.3 Module Orientation in Tape	.35
10.4 Moisture Sensitivity Level	.35
10.5 Tape and Reel Box Dimensions	.35
11. Certifications	36
11.1 CE	.36
11.2 FCC.	.36
11.3 IC	.38
11.4 MIC Japan	.39
11.5 KC South-Korea.	.39
12. Ordering Information	40
13. Support	41
13.1 Device Support	.41
13.1.1 Wireless Starter Kit WSTK6120A	.41
13.2 Documentation Support	.41
13.3 Knowledge Base	.41
13.4 Technical Support	.41
14. Revision History.	42
14.1 Revision 1.4	.42
14.2 Revision 1.3	.42

14.3 Revision 1.2	.42
14.4 Revision 1.1	.42
14.5 Revision 1.0	.42

1. 主要功能

WGM110 模块的主要功能如下。

收音机功能

- 天线
 - 芯片天线: WGM110A
 - 外部天线: WGM110E (u. FL 连接器)
- TX 功率: +16 dBm
- RX 灵敏度: -98 dBm
- 连接范围: 高达 450 m

Wi-Fi 功能

- 802.11: b/g/n
- 位速率: 高达 72.2 Mbps
- 802.11 安全功能: WPA2/WPA 个人版, WPA2/WPA 企业版与 WEP
- STA (静态模式)
- SoftAP (软接入点模式): 多达 5 个客户端
- Wi-Fi Direct
- WPS: 1.0 (按钮)

IP 协议栈

- IP 版本: IPv4
- IP 多播
- TCP: 客户端/服务器
- UDP: 客户端/服务器
- TCP 插座: 20+
- DHCP: 客户端/服务器
- ARP
- DNS: 客户端/服务器
- mDNS
- DNS-SD
- HTTP: 服务器
- TLS/SSL: 客户端

软件 API

- 在 UART/SPI/USB 上设计 BGAPI™ 串行协议 API, 用于调制解调器用途
- 执行 BGAPI 串行协议的 BGLIB™ 主机 API
- 可独立使用的 BGScript™ 脚本语言

软件开发工具

- 免费 SDK

MCU 协议栈

- ARM® Cortex-M3
- 48 MHz
- 128 kB RAM
- 1 MB 闪存

硬件接口

- 主机接口: UART/SPI/USB
- 外围设备接口
 - 2 x USART (UART/SPI)
 - 1 x USB (2.0 全速)
 - 2 x I²C 外围设备接口
- 利用中断使得 GPIO 高达 32
- 8 通道 12 位 ADC
- 2 x 定时器 (每个 3 PWM)
- 实时计数器

电气特性

- 电源电压: 无线电模块为 2.7 V 至 4.8 V
- 电源电压: 处理器模块为 1.98 V 至 3.8 V

功耗

- 261 mA TX 电流 (TX 功率为 +16 dBm)
- 81 mA RX 电流
- 2.4 mA 相关闲置电流消耗
- 18.8 μA 深睡眠电流

环境说明

- 温度范围: -40° C 至 +85° C

模块验证

- FCC
- IC
- 日本
- 韩国

符合 CE 要求

外形尺寸

- 宽 x 长 x 高: 21.0 mm x 14.4 mm x 2.0 mm

Pads in the middle of the Module are intended for ground connections and for RF test and production programming, while pads on the Module edges consist of general purpose input/output, power supply voltage input, ground, and reset signal connections.



The table below lists the power, ground, and reset pads of the WGM110 Module.

Table 2.1. WGM110 Power, Ground, and Reset Pads

silabs.com | Building a more connected world.

Pad number	Function	Description
37, 49	RESETn	Reset signal input. To reset the Module pull this line low. The reset signals resets both the MCU and the Wi-Fi radio. Connected to an internal pull-up, can be left floating if not needed.

2.2 Peripherals and GPIOs

The WGM110 has 32 GPIO pads which can be configured to various peripheral functions, like UART, I²C, USB, etc., or alternatively they can be used as general purpose I/O pads.

These peripheral functions can be typically configured to multiple pad locations on the devices. Available peripherals, locations, and I/Os are described in the following sub-sections.

2.2.1 Peripheral and GPIO Pads

The table below maps out all supported peripheral functions and the GPIOs (pads) they can be routed to.

Table 2.2. Available Peripheral Functions and GPIO Pad Mapping

PERIPHERAL AND GPIO PAD MAPPING																																		
Port Name		PA		PB		PC						PD							PE							PF								
Port Pin #		2	6	11	12	0	1	9	13	14	15	0	1	2	3	4	5	6	7	0	1	2	10	11	12	13	14	15	0	1	2	10	11	
Pad #		6	32	10	11	26	27	33	7	8	9	2	3	28	29	4	5	30	31	19	20	21	12	13	14	15	17	18	34	35	36	22	23	
Pad #																													50	52				
DEBUG																																		
SWCLK																																		
SWDIO																																		
I2C0																																		
SCL							.											.								.				.				
SDA						.											.							.					.					
I2C1																																		
SCL					.															.														
SDA				.															.															
USART0																																		
UART SPI																																		
CTS	CLK						.			.														.										
RTS	CS								.																.									
RX	MISO					.																	.	.										
TX	MOSI				.																	.			.									
USART1																																		
UART SPI																																		
CTS	CLK												.															.						
RTS	CS													.															.					

PERIPHERAL AND GPIO PAD MAPPING																																	
Port Name		PA		PB		PC						PD							PE							PF							
Port Pin #		2	6	11	12	0	1	9	13	14	15	0	1	2	3	4	5	6	7	0	1	2	10	11	12	13	14	15	0	1	2	10	11
Pad #		6	32	10	11	26	27	33	7	8	9	2	3	28	29	4	5	30	31	19	20	21	12	13	14	15	17	18	34	35	36	22	23
Pad #																													50	52			
RX	MISO						•						•					•															
TX	MOSI					•						•							•														
TIMER0																																	
CC0													•																	•			
CC1						•								•																	•		
CC2							•								•																	•	
TIMER1																																	
CC0									•									•					•										
CC1										•									•					•									
CC2				•					•		•														•								
ADC																																	
CH0												•																					
CH1													•																				
CH2														•																			
CH3															•																		
CH4																•																	
CH5																	•																
CH6																		•															
CH7																			•														
USB																																	
DM																																•	
DP																																	•

2.2.2 Peripheral Locations

Many of the peripheral functions can be configured into multiple locations on the GPIO pads. This allows a more flexible configuration of the Wi-Fi Modules GPIOs.

The following table shows the available locations and the corresponding GPIO pads.

Note: Peripheral function signals must always be grouped to a single location, combining signals from several locations to form a peripheral function is not allowed.

The configuration of the peripheral locations is defined in the hardware configuration file. See [UG161: WGM110 Wi-Fi Module Configuration User's Guide](#) for more details.

Table 2.3. GPIO Peripheral Locations

Peripheral		Signal name	LOC 0	LOC 1	LOC 2	LOC 3	LOC 4	LOC 5	LOC 6	NOTE
USART0	SPI	MOSI	PE10			PE13		PC0		
		MISO	PE11			PE12		PC1		
		CLK	PE12		PC9	PC15				
		CS	PE13			PC14				
	UART	TX	PE10			PE13		PC0		1
		RX	PE11			PE12		PC1		1
		CTS	PE12			PC15				
		RTS	PE13			PC14				
USART1	SPI	MOSI	PC0	PD0	PD7					
		MISO	PC1	PD1	PD6					
		CLK		PD2	PF0					
		CS		PD3	PF1					
	UART	TX	PC0	PD0	PD7					2
		RX	PC1	PD1	PD6					2
		CTS		PD2	PF0					
		RTS		PD3	PF1					
I2C0		SCL		PD7			PC1	PF1	PE13	
		SDA		PD6			PC0	PF0	PE12	
I2C1		SCL		PB12	PE1					
		SDA		PB11	PE0					
USB		DM	PF10							
		DP	PF11							
TIMER0		CC0				PD1		PF0		
		CC1				PD2	PC0	PF1		
		CC2	PA2	PA2		PD3	PC1	PF2		
TIMER1		CC0	PC13	PE10			PD6			
		CC1	PC14	PE11			PD7			
		CC2	PC15	PE12		PB11	PC13			
DEBUG		SWCLK	PF0	PF0	PF0	PF0				
		SWDIO	PF1	PF1	PF1	PF1				

Note: The following notes apply to UART Locations:

- **1:** USART0 as UART: LOC 5 can be used as an UART without handshake.
- **2:** USART1 as UART: LOC 0 can be used as an UART without handshake.

2.2.3 GPIO Port Pins

The table below lists available Ports and corresponding Port pins in the WGM110 Module and the pads they can be routed to.

Table 2.4. Available GPIO Ports and Pins and Related Pads on the WGM110 Module

Pin →	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
Port ↓																
Port A										PA6				PA2		
Port B				PB12	PB11											
Port C	PC15	PC14	PC13				PC9								PC1	PC0
Port D									PD7	PD6	PD5	PD4	PD3	PD2	PD1	PD0
Port E	PE15	PE14	PE13	PE12	PE11	PE10								PE2	PE1	PE0
Port F					PF11	PF10								PF2	PF1	PF0

2.2.4 GPIO Input and Output Modes

The GPIO pins on the WGM110 Module can be configured as inputs (options are normal input with pull-up or pull-down or with pull-up with filter or pull-down with filter), outputs (maximum output current 6 mA) or disabled (tristate). The default state of the GPIO pins after reset is "disabled".

For more information on how to configure the GPIO pins and modes, see [WGM110 API Reference Manual](#).

2.2.5 Interrupt Pins

All GPIO pins may be used as interrupts. WGM110 supports up to 14 asynchronous external pin interrupts with the following limitations:

- All pins with the same number are grouped together and multiplexed to trigger one interrupt.
- **Pin 0** from any port cannot be used as an interrupt, because it is reserved for the Module's internal operation.
- **Pin 8 of Port A - F** is not available for external use.

Example:

- If **PB11** is used as an interrupt pin, then the use of **Pin 11** of any other available port as an interrupt is not allowed (**PE11** and **PF11** cannot be used as an interrupt).

2.3 Debug and RF Test Pads

The table below indicates the pads available for debug and RF test connections.

Table 2.5. Debug and RF Test Pads

Debug and RF Test pads						
Port Name	RFPORT				PF	
Pad #	41	43	45	47	34	35
Pad #					50	52
Pad Name	SPIMISO	SPICLK	SPIMOSI	SPICS	PF0	PF1
DEBUG						
SWCLK					•	
SWDIO						•
RF TEST						
SPIMISO	•					
SPIMOSI			•			
SPICLK		•				
SPICS				•		

3. Interfaces

This section describes the features and functionalities of the available host, peripheral, debug, and RF test interfaces.

3.1 Host Interfaces

There are three available host interfaces one of which can be used to connect an external host, typically an MCU, to the WGM110 Wi-Fi Module and use it as a Wi-Fi modem.

3.1.1 UART

UART is one of the available host interfaces on the WGM110 Module, and it is also the default host interface for the WGM110 Modules delivered from the factory.

When using WGM110 UART in transparent mode, we highly recommend to use flow control to avoid the possibility of losing data. Furthermore, we recommend to use DMA on the receiving host, because the SW emulated flow control used in the WGM110 is not as fast as HW flow control, and therefore when CTS is raised, module will most likely still send at least one extra byte. Also using lower baud rates (<1Mbps) can help.

The table below shows the features of the UART host interface:

Table 3.1. UART Host Interface Features and Default Values

Parameter	Features / Supported ranges	Default value
UART baud rate	9600 bps - 6 Mbps	115200 Kbps
Flow control	RTS/CTS	Enabled
Data bits	8 or 9	8
Parity	none, odd, even	None
Stop bits	1 or 2	1
Supported USARTs	USART0 or USART1	-
Location	USART0 • LOC 0 • LOC 3 USART1 • LOC 1 • LOC 2	USART 0 LOC 0
Host protocol	BGAPI serial protocol	BGAPI serial protocol

In the table below is a list of recommended baud rates for UART communication.

Table 3.2. UART baud rates

Desired baud rate [baud/s]	Actual baud rate [baud/s]	Error [%]
9600	9600	0.00
14400	14397	-0.02
19200	19200	0.00
28800	28811	0.04
38400	38400	0.00
57600	57553	-0.08
76800	76677	-0.16
115200	115384	0.16
230400	230769	0.16
256000	255319	-0.27
460800	461538	0.16
921600	923076	0.16
2000000	2000000	0.00
2400000	2400000	0.00
3000000	3000000	0.00
4000000	4000000	0.00
4800000	4800000	0.00
6000000	6000000	0.00

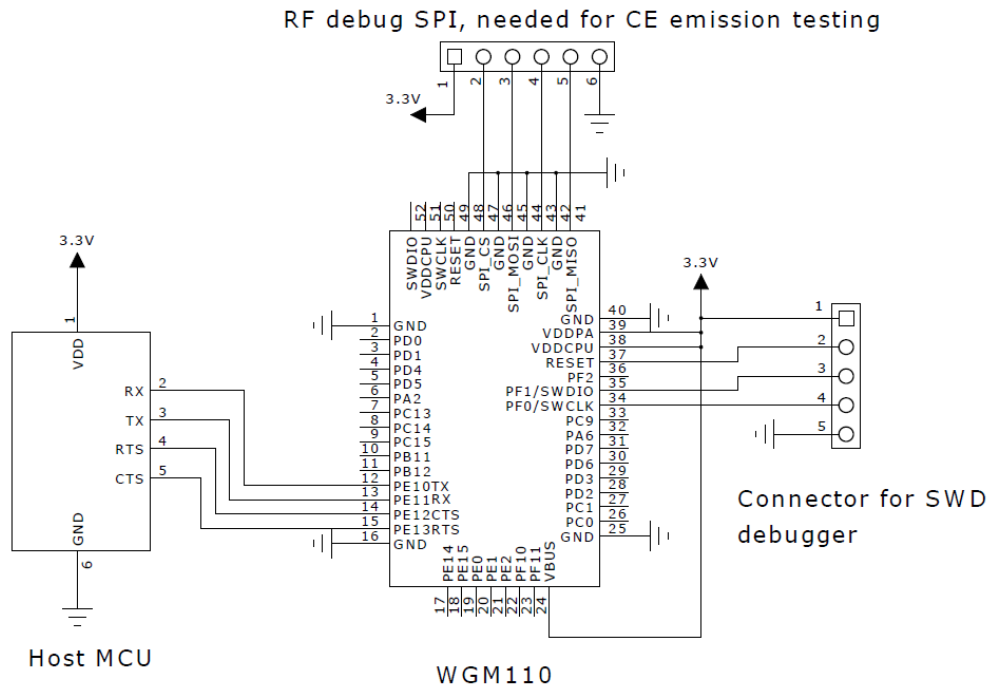


Figure 3.1. Recommended Schematics: Connecting WGM110 with an External Host Using the UART Interface (USART0 Loc 0)

Note: In the figure above the UART interface is wired using **USART0 Location 0** pins.

Note: If handshaking is required, then connect external host **CTS** to **PE13** and external host **RTS** to **PE12**.

Note: A programming connector, as shown in the schematics, must be available in the design to enable WGM110 firmware update.

3.1.2 SPI

SPI is one of the available host interfaces on the WGM110 Module. SPI must be always enabled and configured by the user, because it is not enabled or configured as default.

The table below shows the features of the SPI host interface:

Table 3.3. SPI Host Interface Features

Parameter	Features (value ranges)
SPI mode	SPI slave
Bit rates	9600 bps - 6 Mbps
Bit order	MSB first
Clock polarity and phase	Configurable
Supported USARTs	USART0 and USART1
Supported locations	All locations
Host protocol	BGAPI serial protocol

The following figure shows the recommended schematics for connecting WGM110 with an external host over SPI. In addition to the selected USART/SPI port signals, one additional GPIO pin must be dedicated to be used as a notify signal to inform the SPI Master that data from module is available.

Note: The SPI host interface can only be used as a **SPI Slave**.

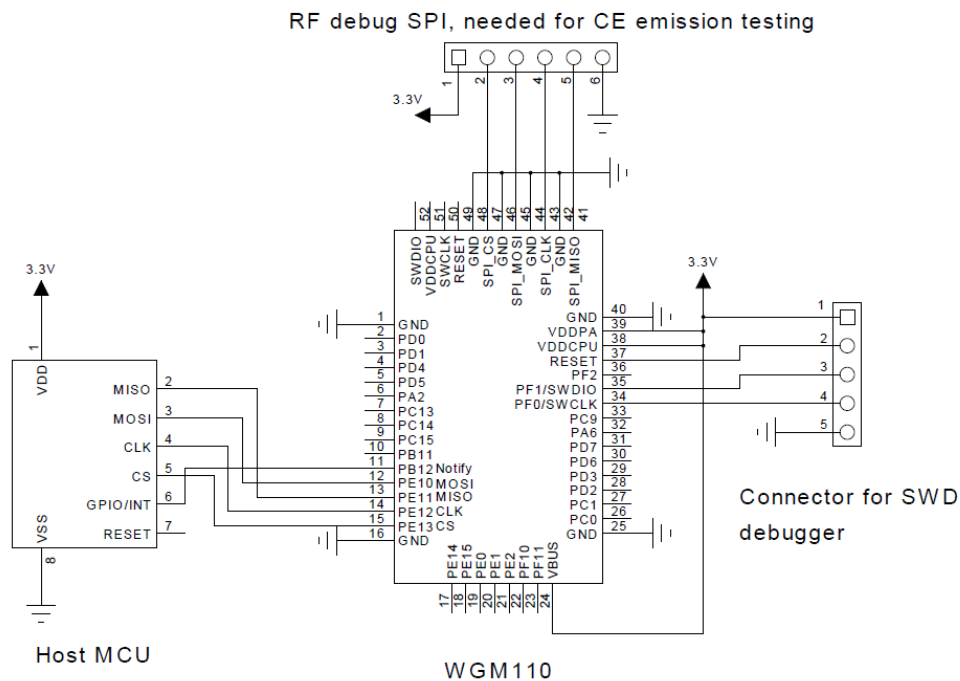


Figure 3.2. Connecting WGM110 with an External Host Using the SPI Interface

Note: In the figure above, the SPI interface is wired using **USART0 Location 0** pins.

Note: Pin **PB12** is configured as an output and used to notify the external host (SPI Master) that the WGM110 Module has data to send to the host.

3.1.3 USB

USB is one of the available host interfaces on the WGM110 Module. USB must be always enabled and configured by the user, because it is not enabled or configured as default.

The table below shows the features of the USB host interface:

Table 3.4. USB Host Interface Features

Parameter	Compatibility
USB mode	USB device
USB version	2.0 Full speed
USB device class	CDC/ACM (COM port)
Host protocol	BGAPI serial protocol

The next figure shows the recommended schematics for connecting WGM110 Module with an external host over USB.

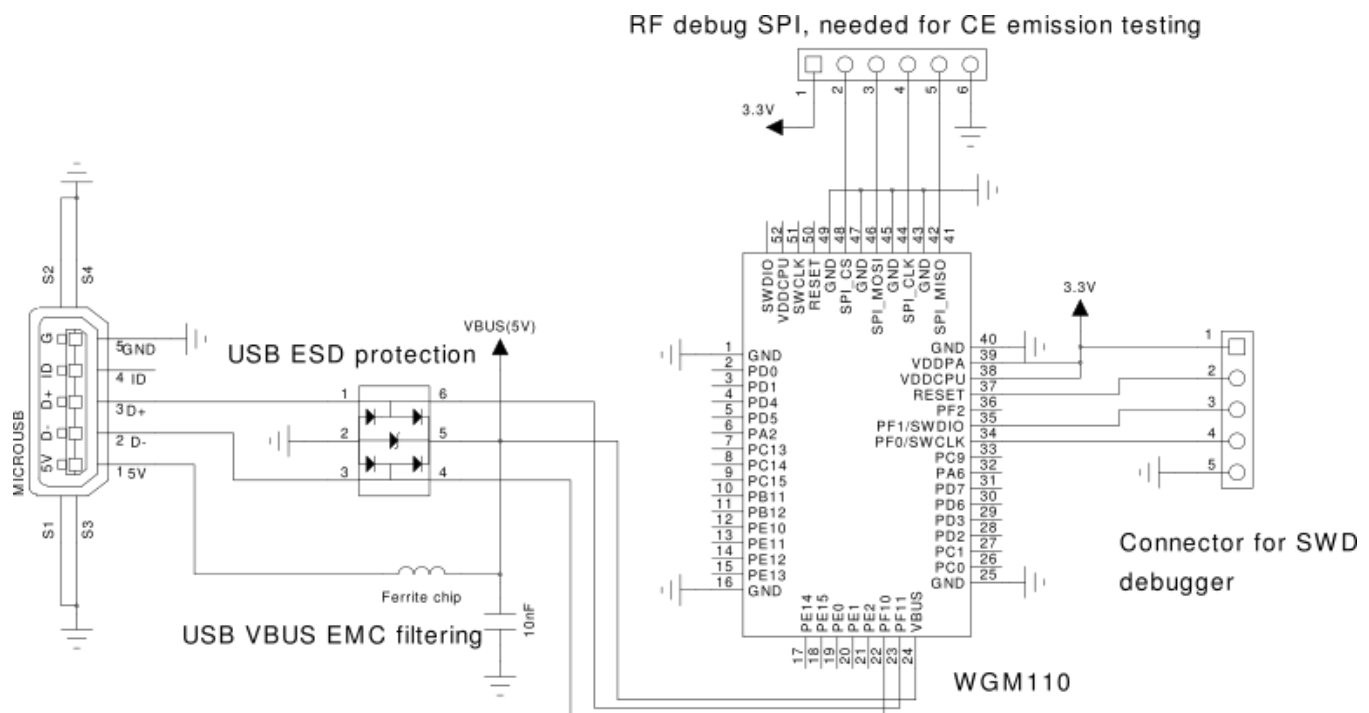


Figure 3.3. Connecting the WGM110 Module with an External Host using the USB Interface

Note: When using the USB interface, the VBUS signal should be connected to the USB host's VBUS line.

Note: If the VBUS line is not available on the host, the module's VBUS signal should be connected to the VDDCPU.

Note: If the USB is not used at all, the VBUS signal can be left unconnected.

3.2 Peripheral Interfaces and Functions

There are several different types of peripheral interface connections available on the WGM110 Module. External sensors and peripheral chips can be connected using the USART (UART/SPI) and I2C interfaces. In addition to the above mentioned connections, WGM110 includes two timers for PWM applications, an 8-channel 12-bit ADC converter and a real time counter.

3.2.1 USART (UART/SPI)

The Universal Synchronous/Asynchronous Receiver/Transmitter (USART) provides a flexible serial I/O interface. It supports full duplex asynchronous UART communication up to 6 Mbps. Both SPI Master and Slave modes are also supported up to 6 Mbps.

Software emulated RTS/CTS handshaking is supported. For this reason there may be up to two extra data bytes transmitted by the Module after the host's RTS has been pulled high.

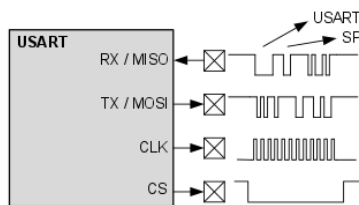


Figure 3.4. USART

3.2.2 I²C

The I²C peripheral provides an interface between the WGM110 Module and a serial I²C bus. It is capable of acting as a I²C Master. Standard-mode is supported, allowing transmission rates up to 100 Kbps.

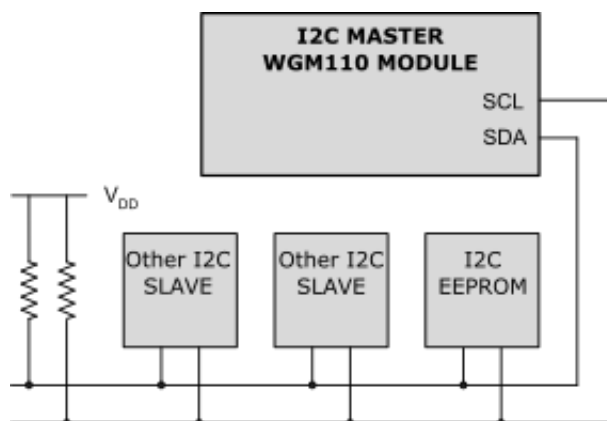


Figure 3.5. WGM110 Acting as an I²C Master with Several I2C Slaves Connected to the Module

3.2.3 Timer / PWM

Timer peripherals count events and can be used to generate PWM outputs. The core of each timer is a 16-bit counter. There are two timers, each with three separate outputs configurable for PWM applications.

3.2.4 Analog to Digital Converter (ADC)

The ADC inside the WGM110 Module is based on Successive Approximation Register (SAR) architecture and has a resolution of up to 12 bits (1 MSPS). The ADC includes user selectable integrated voltage references but also allows the use of an external reference. There are 8 fixed GPIO pins configurable for single-ended ADC inputs.

3.3 Firmware Update and RF Test Interfaces

Firmware updates can be done over the ARM Serial Wire Debug (SWD) interface, which is the recommended firmware update interface for development and production programming.

It is also possible to update the firmware using the Device Firmware Update (DFU) protocol by using an interface configured as the host interface (UART, SPI or USB).

3.3.1 ARM Serial Wire Debug (SWD)

The WGM110 Module contains a 2-wire ARM SWD interface for programming and debugging. It is recommended that the pads of this interface are exposed in the application design to allow firmware updates and debugging.

3.3.2 Device Firmware Upgrade (DFU)

The firmware can be updated over the configured host interface (UART, SPI, or USB) using the Device Firmware Upgrade (DFU) protocol. This method is intended to be used for field updates of the firmware, for example, when updating the WGM110 Module firmware from a connected host using the BGAPI serial protocol.

Note: You cannot update the bootloader using the DFU protocol. Bootloader update must be done using the SWD Debug interface.

Note: In case the DFU recovery mode is not useable for any reason, the SWD bus is always available at boot when the RESET pin of the WGM110 Module is being pulled down.

3.3.3 RF Test Interface

There are dedicated pads on the WGM110 Module that are used to enable the Wi-Fi radio test modes. These test modes would typically be used if RF measurements relating to CE or any other certification requirements are needed. More specifically, RF Test pads are used to enable the TX and RX test modes of the WGM110 Module.

3.3.4 Reference Schematic for SWD Debug and RF Test Interfaces

The schematic below shows the necessary connections needed for using the SWD and RF test interfaces.

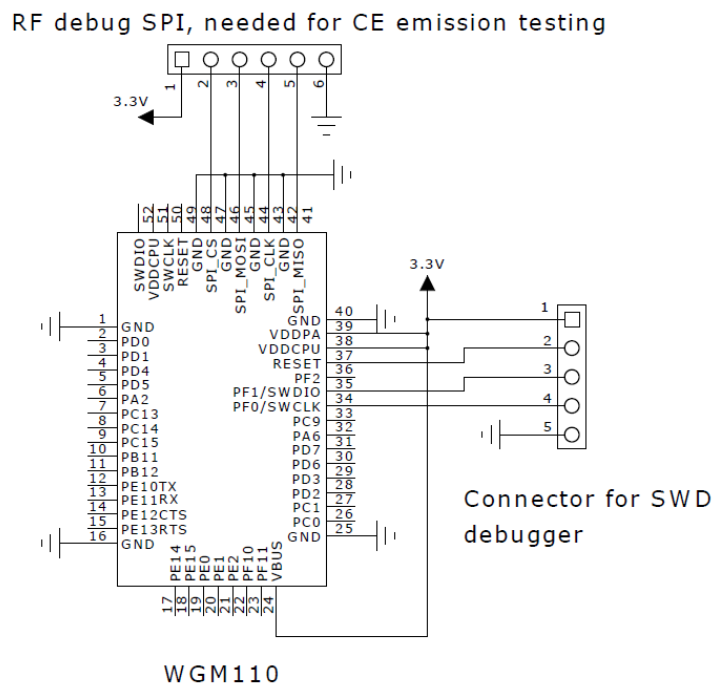


Figure 3.6. SWD Debug and RF Test Interface Connections

3.4 Real Time Counter (RTC)

The Real Time Counter is a 24-bit counter providing timekeeping functions for the WGM110 Module.

4. Module Software

This section gives a short overview of the software provided with the WGM110 Module and describes the basic methods of using the Module. The figure below shows the block diagram of the software provided with the WGM110 Module and how it relates to the software on the external host.

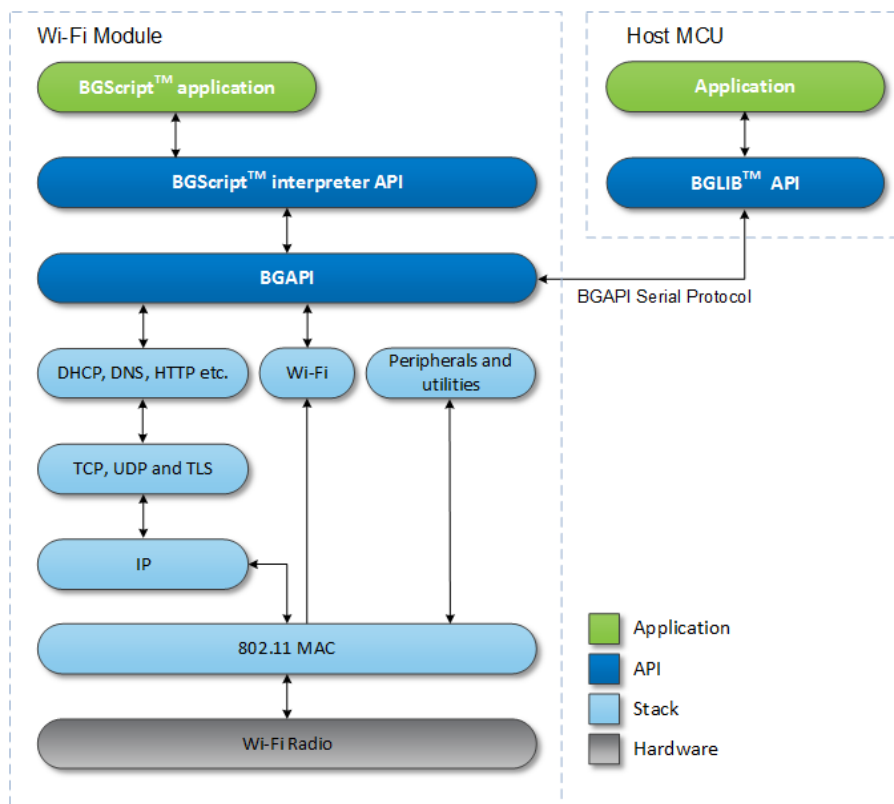


Figure 4.1. WGM110 Software Allows Both BGScript™ Based or Host MCU Based Control of the Module

The WGM110 Module includes full Wi-Fi and IP stacks, an HTTP/HTTPS server, and multiple protocols, such as TCP and UDP. Key security features include WPA2/WPA Personal and Enterprise support and TLS/SSL for end-to-end encryption. The WGM110 SDK contains all necessary tools for developing and deploying IoT applications for the WGM110 Module.

The Wi-Fi Module has been designed to allow flexibility in selecting the most suitable design architecture. There are three main architectural options for using the WGM110 Module:

- Network Co-Processor (NCP) mode, in which the Module is connected to an external host MCU via the BGLIB API
- Stand-alone mode, in which the module is used to run BGScript applications
- Mixed mode, in which is a combination of the two above listed modes

Network Co-Processor (NCP) mode

The NCP mode is the choice to use when there is a need to implement a more complicated IoT application and the resources of an external MCU are needed. In the NCP mode, the external host MCU is connected to the Module using one of the three available host interfaces (UART, SPI, or USB). The WGM110 Module provides a high-level BGAPI to manage Wi-Fi as well as data connections. Silicon Labs provides a thin API layer (BGLib) written in ANSI C for the host, which can take care of creating and parsing the messages sent over the host interface. For evaluation purposes, GUI tools are also provided as part of the SDK.

Data between the WGM110 Module and the external host MCU can be routed either through the BGAPI or via another physical interface. For example, a serial-to-TCP/IP solution, if one UART interface is used for sending and receiving BGAPI commands; the second UART can be bound with a TCP/IP socket. Data written to the second UART will be seamlessly passed to the TCP/IP socket.

Stand-alone mode

The stand-alone mode is especially suitable for more lightweight IoT applications, and there is no need for hosting an external MCU controller. This will naturally result in HW BOM cost savings. The WGM110 Module is natively running and controlled by a BGScript application.

Mixed mode

The WGM110 Module can also be used in a mixed mode, where both the NCP and Stand-alone approaches are used in parallel. In this case the BGScript application on the module can be run completely independent from any MCU action. Normally the approach is to automate certain processes in BGScript (e.g. Wi-Fi network scanning and connection) to relieve the host from doing these.

Note: To learn more about the WGM110 Module software, the SDK and the APIs in general please read the [QSG122: WGM110 Wi-Fi Module Software Quick-Start Guide](#).

Note: For a complete reference of the API, please see the [WGM110 API Reference Manual](#).

5. Hardware Design Guidelines

WGM110 is an easy-to use Module with regard to hardware application design, but certain guidelines must be followed to guarantee optimal performance. These guidelines are listed in the next sub-sections.

5.1 Power Supply Requirements

WGM110 Module consists of two separate internal blocks, the microcontroller and the Wi-Fi radio block. Individual power supplies are needed for both the MCU and the Wi-Fi radio blocks.

The WGM110 Module is designed to operate with a 3.3 V nominal input voltage supplied to the two supply inputs as follows:

- The **VDDCPU** powers the MCU and can be fed with a voltage between 2.0 V and 3.8 V. The regulator supplying VDDCPU should be able to supply at least 30 mA.
- The **VDDPA** pad can be supplied with a voltage between 2.7 V and 4.8 V and supplies the RF power amplifier and the internal switch-mode converter powering the Wi-Fi digital core. VDDPA may draw short peaks up to 350 mA.

In lithium battery powered applications, VDDPA can be connected directly to the battery, while a regulator is needed to supply the VDDCPU with a lower voltage, as needed by the design. Care should be taken that the supply source is capable of supplying enough current for the heavy load peaks of the power amplifier.

External high frequency bypass capacitors are not needed because the module contains the required supply filter capacitors. However, care should be taken to prevent strong switching noise from being superimposed on the supply lines. Such noise can be generated, for example, by on-board charge pump converters used in RS232 level shifters. Note that there is a total of about 20 μF of low ESR ceramic capacitors on the VDDPA line and approximately 2 μF on the VDDCPU line inside the module. When using external regulators to generate regulated supplies for the module, the stability of the regulator with the low ESR provided by these capacitors should be checked. Many low-drop linear regulators and some switched mode regulators are not stable when using ceramic output capacitors. The datasheet of the regulator typically lists recommendations concerning suitable capacitors, including data on ESR range and/or stability curves. A regulator with a statement “*stable with ceramic capacitors*” is recommended.

5.2 PCB Design Guidelines

For optimal performance of the WGM110 Module, please follow these guidelines:

- Place the Module at the edge of the PCB (does not apply to WGM110E), as shown in the figure below.
- Do not place any metal (traces, components, battery, etc.) within the clearance area of the antenna, shown in the figure below as a white rectangle between the pad rows (does not apply to WGM110E).
- Connect all ground pads directly to a solid ground plane.
- Place the ground vias as close to the ground pads as possible.
- Do not place plastic or any other dielectric material in touch with the antenna.

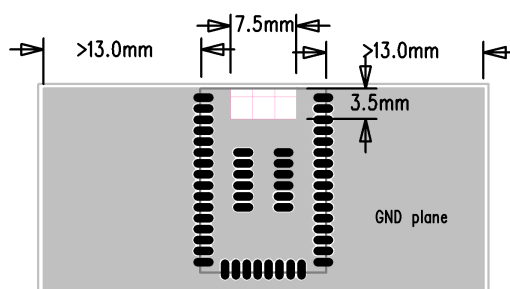


Figure 5.1. Recommended Application PCB Layout for WGM110A Module

The layouts shown in the figure below will result in severely degraded RF-performance.

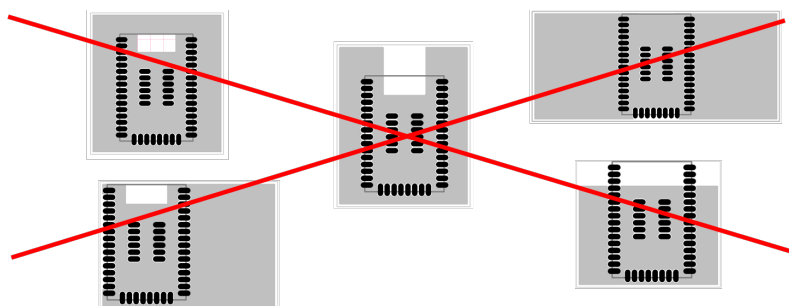


Figure 5.2. Non-optimal Application PCB Layouts for WGM110A Module

The impact of the size of the ground plane on the achievable range of the maximum range available for the WGM110A Module is shown below. As can be seen from the image, the curve indicates that the maximum range is achieved with an approximately 35 - 40 mm wide ground plane. Narrower ground planes can be used but will result in compromised RF performance.

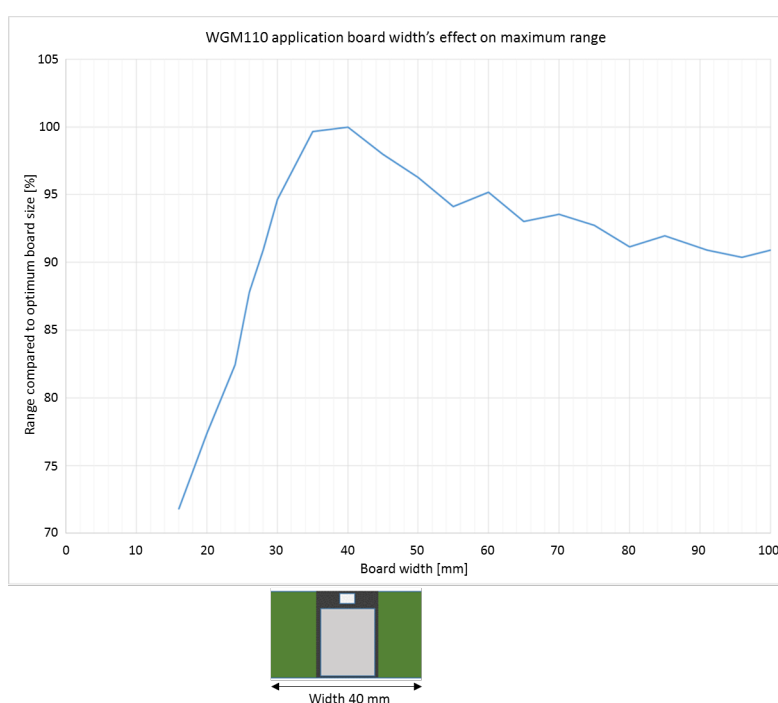


Figure 5.3. Guideline For the Achievable Range vs. Ground Plane Width for WGM110A

5.3 Antenna Design Guidelines

This section contains information regarding the optimal functioning of the antenna when using the WGM110A version. When using the WGM110E version with an external antenna follow the antenna manufacturers design related information typically available from the antenna data sheet.

5.3.1 Effect of Plastic and Metal Materials

Do not place plastic or any other dielectric material in touch with the antenna.

Any metallic objects in close proximity to the antenna will prevent the antenna from radiating freely. The minimum recommended distance of metallic and/or conductive objects is 10 mm in any direction from the antenna except in the directions of the application PCB ground planes.

5.3.2 Locating the Module Close to Human Body

When using the Module in an application where the radio is located close to human body, the human RF exposure must be evaluated. FCC, IC, and CE all have different standards for evaluating the RF exposure and, because of this, each standard will require a different minimum separation distance between the Module and human body. Certification of WGM110 allows the following minimum separation distances without any actions required from the end product manufacturer but the allowed minimum separation distances differ slightly between the WGM110A and WGM110E versions as indicated in the table below.

Table 5.1. Minimum Allowed Separation Distances for WGM110 A and E Variants

Certification	WGM110A	WGM110E
FCC	21 mm	21 mm
IC	25 mm	30 mm
CE	The RF exposure must be evaluated using the end product	The RF exposure must be evaluated using the end product

For FCC and IC, using the Module in end products where the separation distance is smaller than those listed above is allowed but requires evaluation of the RF exposure in the final assembly and applying for a *Class 2 Permissive Change* or *Change of ID* to be applied to the existing FCC/IC certificates of the Module.

For CE certification, RF exposure must be evaluated using the end product in all cases.

Note: Placing the Module in touch or very close to the human body will have a negative impact on the efficiency of the antenna thus reducing range.

6. Electrical Characteristics

This section contains tables with electrical characteristics of WGM110 Module.

6.1 Absolute Maximum Ratings

The values indicated in the table below define the absolute maximum ratings for WGM110 Module.

Table 6.1. Absolute Maximum Ratings

Rating	Min	Max	Unit
Storage Temperature	-40	85	°C
VDDPA	0	6	V
VDDCPU	0	3.8	V
GPIO Terminal Voltages	-0.3	VDDCPU + 0.3	V

6.2 Recommended Operating Conditions

The values indicated in the table below define the recommended operating value ranges for WGM110 Module.

Table 6.2. Recommended Operating Conditions

Rating	Min	Max	Unit
Operating Temperature Range (including internal heating)	-40	85	°C
VDDPA	2.7	4.8	V
VDDCPU	1.98	3.8	V

6.3 Input/Output Terminal Characteristics

The values indicated in the table below define the input and output terminal characteristics for WGM110 Module.

Table 6.3. Digital Input/Output Terminal Electrical Characteristics

Digital terminals	Min	Typ	Max	Unit
Input voltage levels				
VIL input logic level low $1.7\text{ V} \leq \text{VDD} \leq 3.6\text{ V}$	—	—	0.3VDD	V
VIH input logic level high $1.7\text{ V} \leq \text{VDD} \leq 3.6\text{ V}$	0.7 VDD	—	—	V
Output voltage levels				
VOL output logic level low, Vdd = 3.3 V, Iol = 20 mA, strongest drive	—	—	$0.2 \times \text{VDD}$	V
VOH output logic level high Vdd = 3.3 V, Ioh = -20 mA, strongest drive	$0.8 \times \text{VDD}$	—	—	V
Internal pull-up resistor	—	40	—	kΩ

Digital terminals	Min	Typ	Max	Unit
Internal pull-down resistor	—	40	—	kΩ
Pulse width of pulses to be removed by the glitch suppression filter when enabled	10		50	ns

6.4 Power-on Reset

The values indicated in the table below define the power-on reset signal characteristics for WGM110 Module.

Table 6.4. Power-on Reset Characteristics

Power-on Reset	Min	Typ	Max	Unit
Power-on reset threshold (rising edge)	—	—	1.96	V

6.5 Analog Digital Converter (ADC)

The values indicated in the table below define the ADC characteristics for WGM110 Module.

Table 6.5. ADC Characteristics

Power-on Reset	Min	Typ	Max	Unit
Input impedance	1	—	—	MΩ
Input voltage range (single ended)	0	—	Vref	V
Common mode input range	0	—	VDDCPU	V
Range of external reference voltage	1.25	—	VDDCPU	V
Resolution	—	—	12	bits
ADC clock frequency	—	—	13	MHz
Acquisition time (programmable)	1	—	256	ADC CLK cycles
Conversion time (6-bit)	7	—	—	ADC CLK cycles
Conversion time (8-bit)	11	—	—	ADC CLK cycles
Conversion time (12-bit)	13	—	—	ADC CLK cycles
Offset error (single-ended)	—	0.3	—	mV
Integral non-linearity	—	±1.2	±3	LSB

6.6 Power Consumption

The values indicated in the table below define the power consumption characteristics and the typical power consumption in practical use cases respectively for WGM110 Module.

Table 6.6. Typical Power Consumption for Different Operating Modes

Wi-Fi Chipset State	CPU EM mode	Current	Unit	Description	802.11 Standard
Continuous transmit	EM0	261	mA	+16 dBm, 1 Mbps	b
Continuous transmit	EM0	242	mA	+14 dBm, 54 Mbps	g / n
Continuous receive	EM0	81	mA	1 Mbps or 54 Mbps	—
Powered off	EM0	17	mA	CPU executing program	—
Powered off	EM1	7.1	mA	CPU in idle state	—
Powered off	EM2	18.8	μA	Module deepest power down state	—
Sleep, unassociated	EM2	117	μA	CPU and Wi-Fi chipset in sleep state	—
Associated, idle	EM2	2.4	mA	DTIM=1, 100 ms beacon period	—
Associated, idle	EM2	1.2	mA	DTIM=3, 100 ms beacon period	—

7. RF Characteristics

This section contains tables with RF characteristics of the WGM110 Module.

7.1 Supported Frequencies

Supported frequencies for WGM110 Module are listed in the table below.

Table 7.1. Supported Frequencies

Parameter	Min	Max	Unit
Frequency	2412	2472	MHz
Channels CLIENT MODE	1	13	—
Channels AP MODE	1	11	—

Note: WGM110 detects the regulatory domain according to 802.11d and adjusts the number of approved channels accordingly.

7.2 Typical Receiver Sensitivity

Typical receiver sensitivity values for the WGM110 Module at different throughput values are listed in the table below.

Table 7.2. Typical Receiver Sensitivity

802.11b	Typ	802.11g	Typ	802.11n Short GI	Typ	802.11n Long GI	Typ
1 Mbps	-98 dBm	6 Mbps	-93 dBm	6.5 Mbps	-92 dBm	7.2 Mbps	-93 dBm
2 Mbps	-96 dBm	9 Mbps	-92 dBm	13 Mbps	-88 dBm	14.4 Mbps	-91 dBm
5.5 Mbps	-95 dBm	12 Mbps	-90 dBm	19.5 Mbps	-86 dBm	21.7 Mbps	-88 dBm
11 Mbps	-90 dBm	18 Mbps	-87 dBm	26 Mbps	-83 dBm	28.9 Mbps	-85 dBm
—	—	24 Mbps	-85 dBm	39 Mbps	-79 dBm	43.3 Mbps	-81 dBm
—	—	36 Mbps	-81 dBm	52 Mbps	-75 dBm	57.8 Mbps	-76 dBm
—	—	48 Mbps	-76 dBm	58.5 Mbps	-72 dBm	65 Mbps	-73 dBm
—	—	54 Mbps	-74 dBm	65 Mbps	-69 dBm	72.2 Mbps	-70 dBm

7.3 Transmitter Power at Maximum Setting

Transmitter output power values at maximum setting for WGM110 Module are listed in the table below.

Table 7.3. Transmitter Output Power at Maximum Setting

Modulation type	Typ	Unit
802.11b	+16	dBm
802.11g	+15	dBm
802.11n	+15	dBm

7.4 Antenna Characteristics

This sub-section contains information describing the characteristics of the chip antenna on WGM110 Module.

7.4.1 Typical Antenna Performance (WGM110A)

Typical antenna performance values for WGM110A Module are listed in the following table.

Table 7.4. Typical Antenna Performance for WGM110 Module

Parameter	Typ	Unit
Antenna efficiency	- 2 ... -6	dB
Antenna peak gain	+1 ... -2	dBi

7.4.2 Typical Radiation Pattern Plot (WGM110A)

Typical 3D radiation pattern plot for the Wizard Gecko WGM110A Module is shown in the figure below. Application layout and mechanics in close proximity to the antenna have an effect on the antenna radiation pattern, antenna efficiency, and peak gain. Optimal PCB size with regard to the effect on the antenna performance is indicated in [Figure 5.3 Guideline For the Achievable Range vs. Ground Plane Width for WGM110A on page 18](#). Typically peak gain is achieved in the direction pointing away from the largest ground plane.

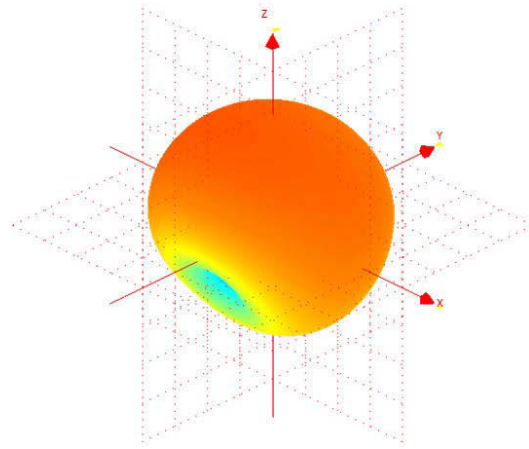


Figure 7.1. Typical 3D Radiation Pattern for WGM110A Module

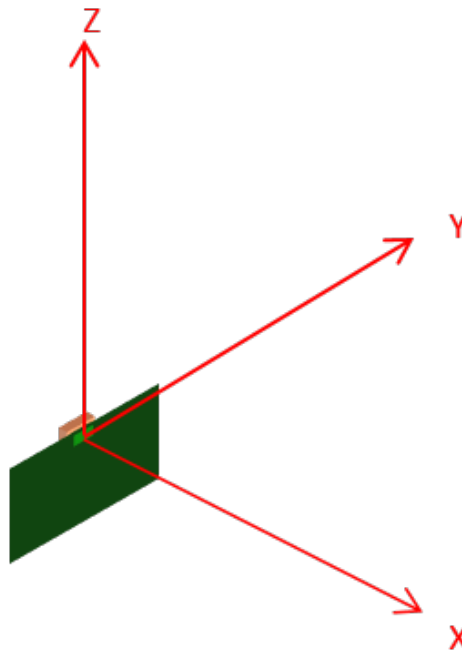


Figure 7.2. Corresponding WGM110A Module Position

7.4.3 Qualified Antenna Types (WGM110E)

This device has been designed to operate with antennas having a maximum gain of 2.8 dB (see table below). Antenna types not listed in the table and/or antennas having a gain greater than 2.8 dB are strictly prohibited for use with this device. The required antenna impedance is 50 Ω .

Table 7.5. Qualified Antenna Types for WGM110E

Qualified Antenna Types for WGM110E	
Antenna type	Maximum Gain
Dipole	2.8 dBi

Any antenna that is of the same type and of equal or less directional gain as listed in the above table can be used without a need for retesting. To reduce potential radio interference to other users, the antenna type and its gain should be selected so that the equivalent isotropically radiated power (e.i.r.p.) is not more than that permitted for successful communication. Using an antenna of a different type or gain more than 2.8 dBi will require additional testing for FCC, CE and IC certification.

Note: Use of antennas not complying to the type and maximum gain requirements set in this section will require the user to perform additional testing for FCC, CE and IC certifications.

8. Physical Dimensions and PCB Land Pattern

This section contains dimensional drawings of the WGM110 Module and the recommended application PCB land pattern dimensions. The indicated dimensions apply for both WGM110A and WGM110E versions, the only difference physically being the u.FI connector on the WGM110E version.

8.1 Module Top View Dimensions

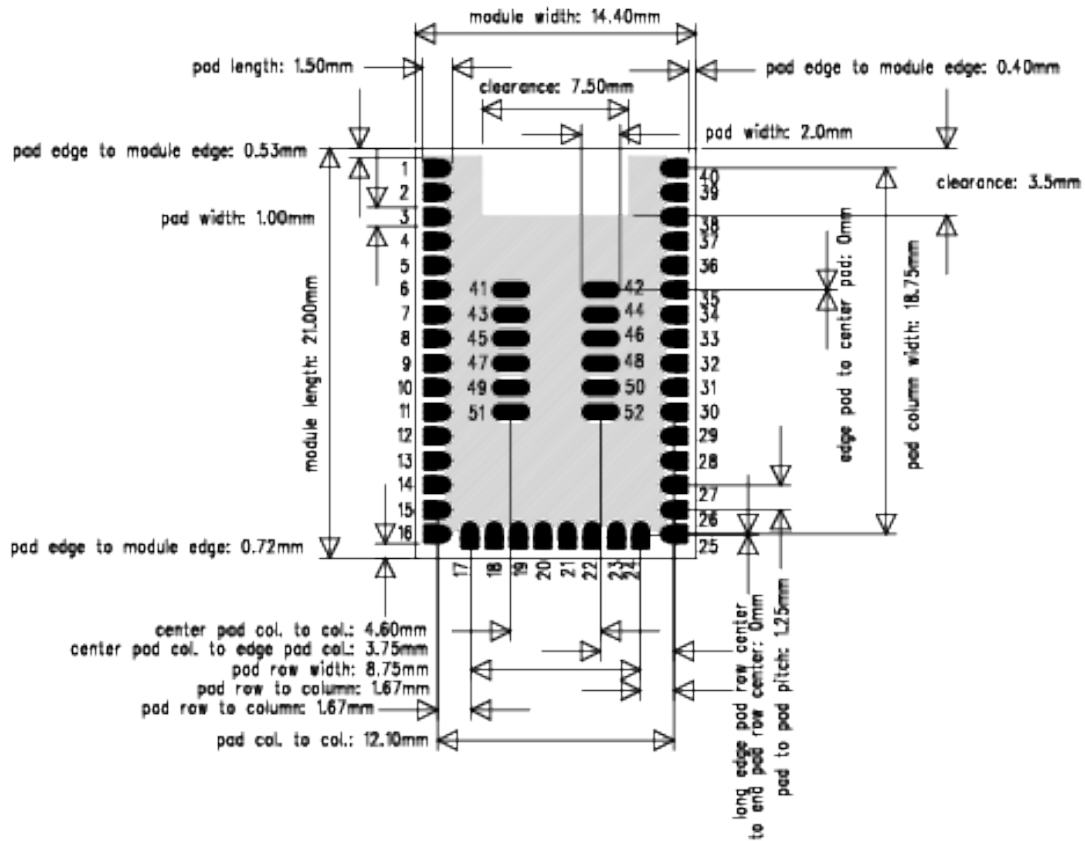


Figure 8.1. Top View Dimensions

Note: The clearance area indicated in the figure above is required only for WGM110A.

8.2 Module Side View Dimensions

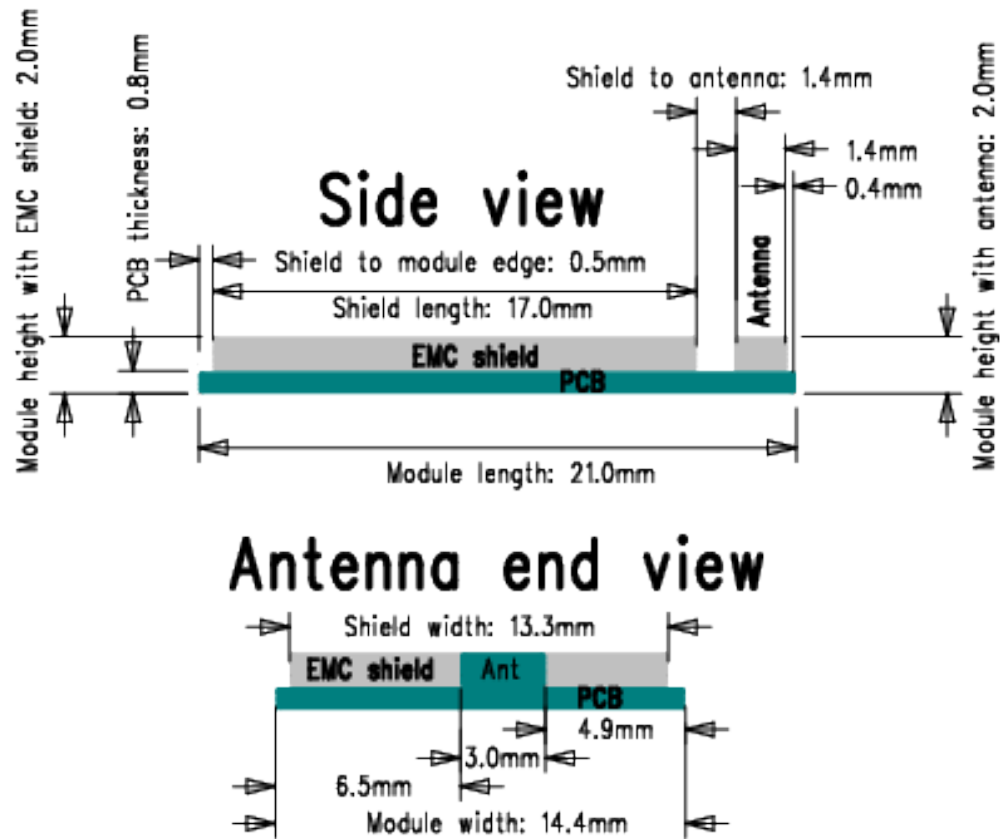
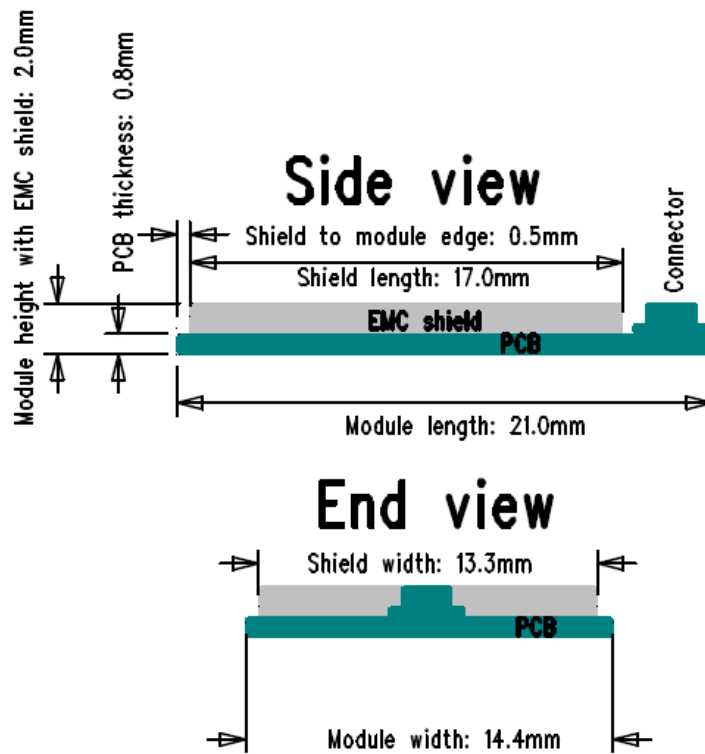


Figure 8.2. Side and Antenna End View Dimensions (WGM110A)



Tolerance $\pm 0.1\text{mm}$ for all measurements

Figure 8.3. Side and Antenna View Dimensions (WGM110E)

8.3 u.FL Connector Placement (WGM110E)

The WGM110E type has an u.FL connector for attaching an external antenna. The location of the u.FL connector in relation to the Module package is shown in the figure below.

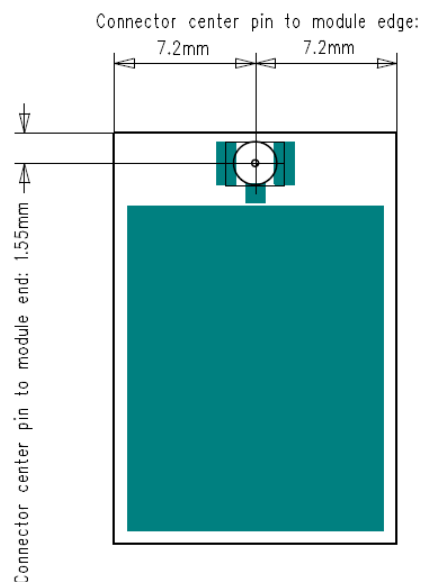


Figure 8.4. u.FL Connector Placement on the WGM110E Module

8.4 Recommended Application PCB Land Pattern

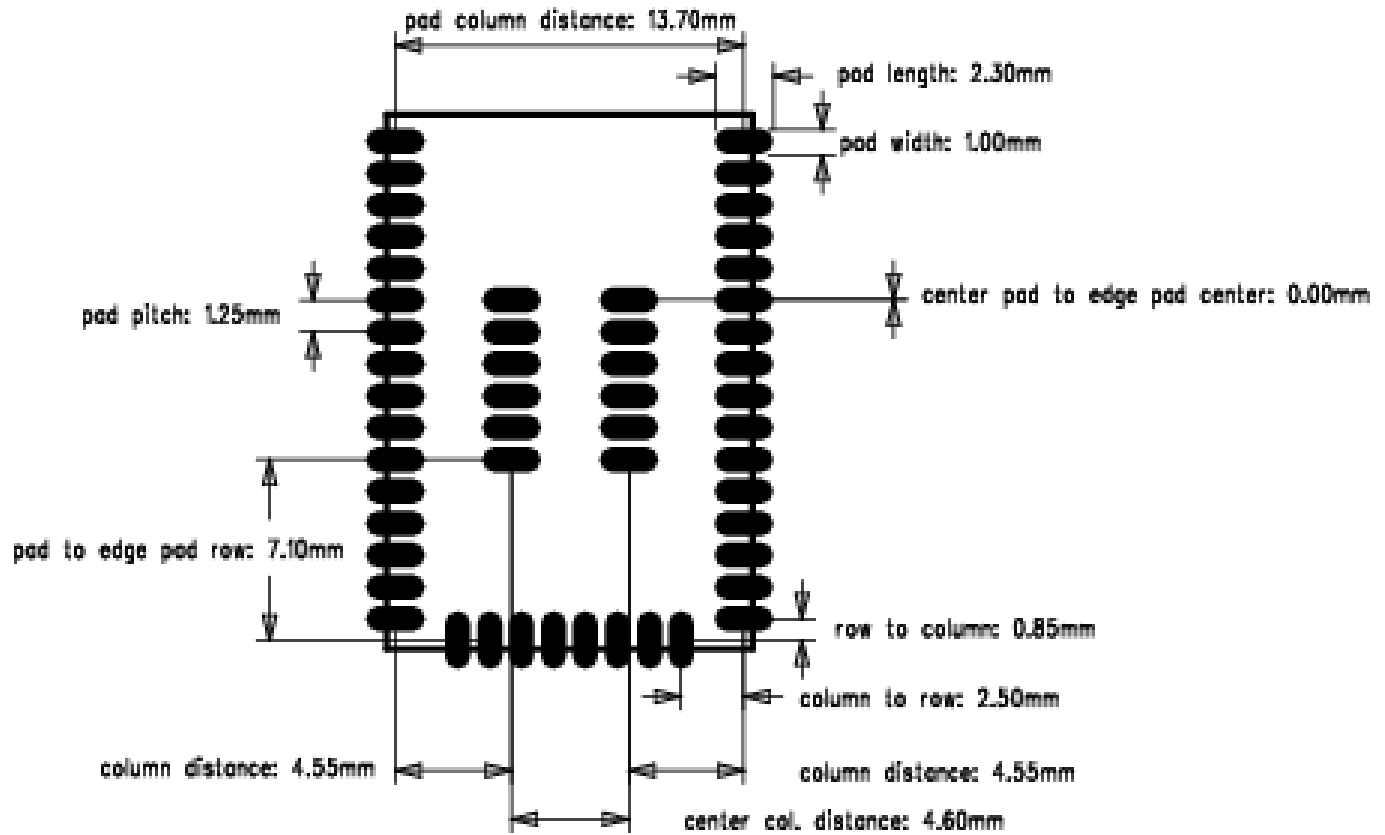


Figure 8.5. Recommended Application PCB Land Pattern

9. Soldering Recommendations

This section describes the soldering recommendations regarding WGM110 Module.

WGM110 is compatible with industrial standard reflow profile for Pb-free solders. The reflow profile used is dependent on the thermal mass of the entire populated PCB, heat transfer efficiency of the oven, and particular type of solder paste used

- Refer to technical documentations of particular solder paste for profile configurations.
- Avoid using more than two reflow cycles.
- Aperture size of the stencil should be 1:1 with the pad size.
- A no-clean, type-3 solder paste is recommended.
- For further recommendation, please refer to the JEDEC/IPC J-STD-020, IPC-SM-782 and IPC 7351 guidelines..

10. Tape and Reel Packaging

This section contains information regarding the tape and reel packaging for the Wizard Gecko WGM110 Wi-Fi Module including shipment packaging information.

10.1 Tape Material and Dimensions

- Tape material: Polystyrene (PS)
- Tape length/reel: 53.4 m
- Tape surface resistivity: $10^4 \dots 10^9 \Omega/\text{sq.}$
- Curvature of the tape / 100 mm of tape: Complies with EIA-481 standard
- Maximum radius of unmarked round corners: 0.2 mm
- Cumulative tolerance of any 10 consecutive sprocket holes: $\pm 0.2 \text{ mm}$
- Cover tape peel strength: The peeling force required to tear the cover tape from the carrier tape will fall within the range of 0.1 Newton to 1.3 Newton (10 to 130 grams) at peeling speed to 300 mm per minute. This complies with the EIA standard.
- Cover tape adhesion method: pressure sensitive



10.2 Reel Material and Dimensions

- Reel material: Polystyrene (PS)
- Reel diameter: 13 inches (330 mm)
- Number of modules per reel: 500 pcs
- Environmental standard of reel materials: Delta Management Standard for Environment related substances
- Disk deformation, folding whitening and mold imperfections: Not allowed
- Disk set: consists of two 13 inch (330 mm) rotary round disks and one central axis (100 mm)
- Antistatic treatment: Required
- Surface resistivity: $10^8 - 10^{11} \Omega/\text{cm}^2$

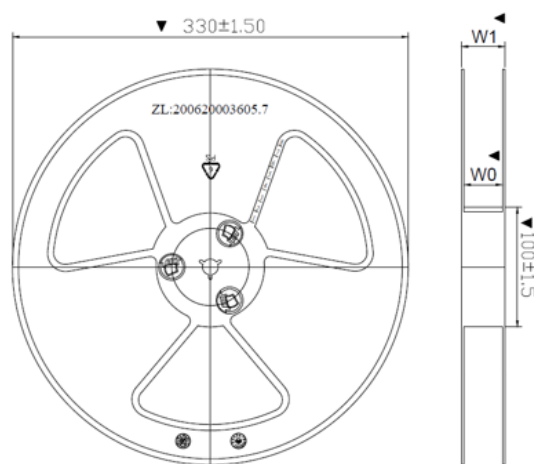


Figure 10.4. Reel Dimensions - Side View

Symbol	Dimensions [mm]
W0	45.0 ± 0.5
W1	50.0 ± 1.0

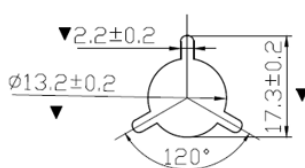


Figure 10.5. Central Axis Dimensions

10.3 Module Orientation in Tape

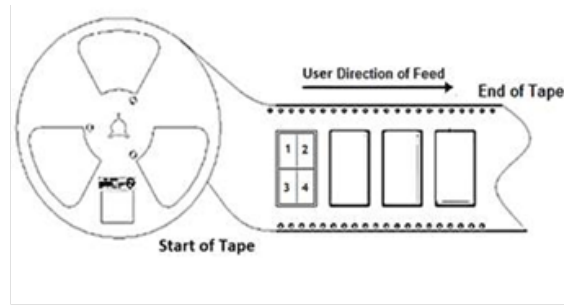


Figure 10.6. Module Orientation in Tape

10.4 Moisture Sensitivity Level

WGM110 Module reels are delivered in packing which conforms to MSL3 (Moisture Sensitivity Level 3) requirements.

10.5 Tape and Reel Box Dimensions

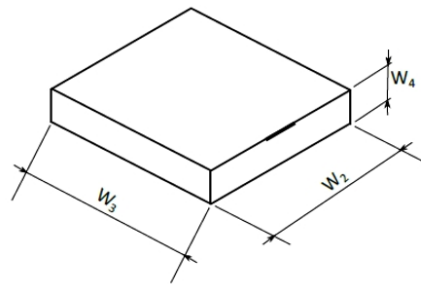


Figure 10.7. Tape and Reel Box Dimensions

Symbol	Dimensions [mm]
W_2	368
W_3	338
W_4	72

11. Certifications

The certifications for the WGM110 Wi-Fi Module are listed in this section.

11.1 CE

The WGM110 Module is in conformity with the essential requirements and other relevant requirements of the R&TTE Directive (1999/5/EC). This device is compliant with the following standards:

- **Safety:** EN 60950
- **EMC:** EN 301 489
- **Spectrum:** EN 300 328

A formal DoC is available from www.silabs.com.

11.2 FCC

This device complies with Part 15 of the FCC Rules. Operation is subject to the following two conditions:

1. This device may not cause harmful interference, and
2. This device must accept any interference received, including interference that may cause undesirable operation.

Any changes or modifications not expressly approved by Silicon Labs could void the user's authority to operate the equipment.

FCC RF Radiation Exposure Statement:

This equipment complies with FCC radiation exposure limits set forth for an uncontrolled environment. End users must follow the specific operating instructions for satisfying RF exposure compliance. This transmitter meets both portable and mobile limits as demonstrated in the RF Exposure Analysis. This transmitter must not be co-located or operating in conjunction with any other antenna or transmitter except in accordance with FCC multi-transmitter product procedures. As long as the condition above is met, further transmitter testing will not be required. However, the OEM integrator is still responsible for testing their end-product for any additional compliance requirements required with this module installed (for example, digital device emissions, PC peripheral requirements, etc.).

OEM Responsibilities to comply with FCC Regulations

The WGM110 Module has been certified for integration into products only by OEM integrators under the following condition:

- The antenna(s) must be installed such that a minimum separation distance of 21 mm (WGM110A and WGM110E) is maintained between the radiator (antenna) and all persons at all times.
- The transmitter module must not be co-located or operating in conjunction with any other antenna or transmitter except in accordance with FCC multi-transmitter product procedures.

As long as the conditions above are met, further transmitter testing will not be required. However, the OEM integrator is still responsible for testing their end-product for any additional compliance requirements required with this module installed (for example, digital device emissions, PC peripheral requirements, etc.).

Note: In the event that this condition cannot be met (for certain configurations or co-location with another transmitter), then the FCC authorization is no longer considered valid and the FCC ID cannot be used on the final product. In these circumstances, the OEM integrator will be responsible for re-evaluating the end product (including the transmitter) and obtaining a separate FCC authorization.

End Product Labeling

The WGM110 Module is labeled with its own FCC ID. If the FCC ID is not visible when the module is installed inside another device, then the outside of the device into which the module is installed must also display a label referring to the enclosed module. In that case, the final end product must be labeled in a visible area with the following:

"Contains Transmitter Module FCC ID: QOQ-WGM110"

or

"Contains FCC ID: QOQ-WGM110"

The OEM integrator must not provide information to the end user regarding how to install or remove this RF module or change RF related parameters in the user manual of the end product.

To comply with FCC RF radiation exposure limits for general population, the antenna(s) used for this transmitter must be installed such that a minimum separation distance of 21 mm (WGM110A and WGM110E) is maintained between the radiator (antenna) and all persons at all times and must not be co-located or operating in conjunction with any other antenna or transmitter.

11.3 IC

IC (English)

This radio transmitter has been approved by Industry Canada to operate with the embedded chip antenna. Other antenna types are strictly prohibited for use with this device.

This device complies with Industry Canada's license-exempt RSS standards. Operation is subject to the following two conditions:

1. This device may not cause interference; and
2. This device must accept any interference, including interference that may cause undesired operation of the device.

RF Exposure Statement

Exception from routine SAR evaluation limits are given in RSS-102 Issue 5. WGM110A meets the given requirements when the minimum separation distance to human body is 25 mm and WGM110E when the minimum separation distance to human body is 30 mm. RF exposure or SAR evaluation is not required when the separation distance is 25 mm (WGM110A) / 30 mm (WGM110E) or more. If the separation distance is less than 25 mm (WGM110A) / 30 mm (WGM110E) the OEM integrator is responsible for evaluating the SAR.

OEM Responsibilities to comply with IC Regulations

The WGM110 Module has been certified for integration into products only by OEM integrators under the following conditions:

- The antenna(s) must be installed such that a minimum separation distance of 25 mm (WGM110A) / 30 mm (WGM110E) is maintained between the radiator (antenna) and all persons at all times.
- The transmitter module must not be co-located or operating in conjunction with any other antenna or transmitter.

As long as the two conditions above are met, further transmitter testing will not be required. However, the OEM integrator is still responsible for testing their end-product for any additional compliance requirements required with this module installed (for example, digital device emissions, PC peripheral requirements, etc.).

Note: In the event that these conditions cannot be met (for certain configurations or co-location with another transmitter), then the IC authorization is no longer considered valid and the IC ID cannot be used on the final product. In these circumstances, the OEM integrator will be responsible for re-evaluating the end product (including the transmitter) and obtaining a separate IC authorization.

End Product Labeling

The WGM110 Module is labeled with its own IC ID. If the IC ID is not visible when the module is installed inside another device, then the outside of the device into which the module is installed must also display a label referring to the enclosed module. In that case, the final end product must be labeled in a visible area with the following:

"Contains Transmitter Module IC: 5123A-WGM110"

or

"Contains IC: 5123A-WGM110"

The OEM integrator has to be aware not to provide information to the end user regarding how to install or remove this RF module or change RF related parameters in the user manual of the end product.

IC (Français)

Cet émetteur radio (IC : 5123A-WGM110) a reçu l'approbation d'Industrie Canada pour une exploitation avec l'antenne puce incorporée. Il est strictement interdit d'utiliser d'autres types d'antenne avec cet appareil.

Le présent appareil est conforme aux CNR d'Industrie Canada applicables aux appareils radio exempts de licence. L'exploitation est autorisée aux deux conditions suivantes:

1. L'appareil ne doit pas produire de brouillage;
2. L'utilisateur de l'appareil doit accepter tout brouillage radioélectrique subi, même si le brouillage est susceptible d'en compromettre le fonctionnement.

Déclaration relative à l'exposition aux radiofréquences (RF)

Les limites applicables à l'exemption de l'évaluation courante du DAS sont énoncées dans le CNR 102, 5e édition. L'appareil WGM110 répond aux exigences données quand la distance de séparation minimum par rapport au corps humain est inférieure ou égale à 25 mm (WGM110A) / 30 mm (WGM110E). L'évaluation de l'exposition aux RF ou du DAS n'est pas requise quand la distance de séparation est de 25 mm ou plus (WGM110A) / 30 mm ou plus (WGM110E). Si la distance de séparation est inférieure à 25 mm (WGM110A) / 30 mm (WGM110E), il incombe à l'intégrateur FEO d'évaluer le DAS.

Responsabilités du FEO ayant trait à la conformité avec les règlements IC

Le Module WGM110 a été certifié pour une intégration dans des produits uniquement par les intégrateurs FEO dans les conditions suivantes:

- La ou les antennes doivent être installées de telle façon qu'une distance de séparation minimum de 25 mm (WGM110A) / 30 mm (WGM110E) (soit maintenue entre le radiateur (antenne) et toute personne à tout moment.
- Le module émetteur ne doit pas être installé au même endroit ou fonctionner conjointement avec toute autre antenne ou émetteur.

Dès lors que les deux conditions ci-dessus sont respectées, d'autres tests de l'émetteur ne sont pas obligatoires. Cependant, il incombe toujours à l'intégrateur FEO de tester la conformité de son produit final vis-à-vis de toute exigence supplémentaire avec ce module installé (par exemple, émissions de dispositifs numériques, exigences relatives aux matériels périphériques PC, etc).

Note: S'il s'avère que ces conditions ne peuvent être respectées (pour certaines configurations ou la colocation avec un autre émetteur), alors l'autorisation IC n'est plus considérée comme valide et l'identifiant IC ne peut plus être employé sur le produit final. Dans ces circonstances, l'intégrateur FEO aura la responsabilité de réévaluer le produit final (y compris l'émetteur) et d'obtenir une autorisation IC distincte.

Étiquetage du produit final

L'étiquette du Module WGM110 porte son propre identifiant IC. Si l'identifiant IC n'est pas visible quand le module est installé à l'intérieur d'un autre appareil, l'extérieur de l'appareil dans lequel le module est installé doit aussi porter une étiquette faisant référence au module qu'il contient. Dans ce cas, une étiquette comportant les informations suivantes doit être collée sur une partie visible du produit final.

"Contient le module émetteur IC: 5123A-WGM110"

or

"Contient IC : 5123A-WGM110"

L'intégrateur FEO doit être conscient de ne pas fournir d'informations à l'utilisateur final permettant d'installer ou de retirer ce module RF ou de changer les paramètres liés aux RF dans le mode d'emploi du produit final.

11.4 MIC Japan

The WGM110 Module is certified for Japan.

Certification number: **209-J00197**.

Since September 1, 2014 it is allowed (and highly recommended) that a manufacturer who integrates a radio module in their host equipment can place the certification mark and certification number (the same marking/number as depicted on the label of the radio module) on the outside of the host equipment. The certification mark and certification number must be placed close to the text in the Japanese language which is provided below. This change in the Radio Law has been made in order to enable users of the combination of host and radio module to verify if they are actually using a radio device which is approved for use in Japan.

当該機器には電波法に基づく、技術基準適合証明等を受けた特定無線設備を装着している。

Figure 11.1. Text to be Placed on the Housing of the End-user Device

Translation of the text in the figure above:

"This equipment contains specified radio equipment that has been certified to the Technical Regulation Conformity Certification under the Radio Law."

11.5 KC South-Korea

The WGM110 Module is certified for South-Korea.

This product has not been tested for SAR in South-Korea. The module antenna needs to have 20cm or more separation to human body in end application. If a closer proximity to a human body is required, SAR measurement must be performed for the end product.

WGM110A Certification number: **MSIP-CRM-BGT-WGM110**.

WGM110E Certification number: **MSIP-CRM-BGT-WGM110E**.

12. Ordering Information

This section contains cut reel (100 pcs) and full reel (500 pcs) ordering information for WGM110 Module. WGM110 Module offer a WGM110A version with integrated antenna and WGM110E version with an U.FL external antenna connector.

WGM110A1MV2 (orderable part number / cut reel) and WGM110A1MV2R (orderable part number / full reel) are the product codes for the full production (certified) version of the WGM110 Wizard Gecko Wi-Fi™ Module. The certification codes are printed on the metallic RF shield of the WGM110 Module.

WGM110A1MV1 (cut reel) and WGM110A1MV1 (full reel) are the product codes for the pre-production (non-certified) version of the Module. The only difference of the the V1 and V2 Module versions is the certification markings on the shield of the V2 version.

Note: The only visual difference between pre-production and production Module versions are the certification codes printed on the RF shield.

Silicon Labs reserves the right to deliver WGM110A1MV2 or WGM110A1MV2R (production version) for customers ordering WGM110A1MV1 (pre-production version) and WGM110E1MV2 or WGM110E1MV2R (production version) for customers ordering WGM110E1MV1 (pre-production version).

Table 12.1. WGM110 Ordering Information

Part Number	Description	Features
WGM110A1MV2	WGM110 Wi-Fi Module with internal chip antenna Cut reel	Packaging: 100 pcs cut reel Status: Full production version
WGM110A1MV2R	WGM110 Wi-Fi Module with internal chip antenna Full reel	Packaging: 500 pcs tape and reel Status: Full production version
WGM110E1MV2	WGM110 Wi-Fi Module with U.FL antenna connector. Cut Reel	Packaging: 100 pcs cut reel Status: Full production version
WGM110E1MV2R	WGM110 Wi-Fi Module with U.FL antenna connector. Full reel	Packaging: 500pcs tape and reel Status: Full production version
SLWSTK6120A	Wi-Fi Module Wireless Starter Kit	WGM110 Wi-Fi Module Radio Board WSTK Main Board Expansion Board (buttons, leds, accelerometer, joystick) Accessories

13. Support

This section lists the available support provided by Silicon Labs for the WGM110 Module.

13.1 Device Support

Silicon Labs provides support material to help test, evaluate, and program the WGM110 Module. The following sub-section describes the Wireless Starter Kit WSTK6120A in more detail.

13.1.1 Wireless Starter Kit WSTK6120A

Silicon Labs Wireless Starter Kit WSTK6120A provides a platform which enables easy testing and programming of the WGM110 Module. The kit includes the WSTK Mainboard, the BRD4320A Radio Board with the WGM110 Module installed on it and an Add-On Board BRD8006A, an external battery holder for 2x AA batteries, and USB cables.

The WGM110 Module on the Radio Board has firmware which includes a demo software. The WSTK kit provides the easiest and most recommendable way of getting started on application development using the WGM110 Module.

13.2 Documentation Support

Silicon Labs offers a set of documents which provide further information required for developing applications based on the WGM110 Module. These documents are available in the web from the Silicon Labs [Document Library](#) and include the following:

- *UG172: Wizard Gecko Wi-Fi® Module Wireless Starter Kit SLWSTK6120A User's Guide*
- *Wizard Gecko WGM110 Wi-Fi® Module Radio Board BRD4320A Reference Manual*
- *QSG119: Wizard Gecko WSTK Quick-Start Guide*
- *AN967: Wizard Gecko WSTK Demo Walkthrough*
- *UG160: Wizard Gecko BGTool™ User's Guide*
- *UG170: Wizard Gecko BGScript™ User's Guide*
- *UG161: WGM110 Wi-Fi® Module Configuration User's Guide*
- *QSG122: WGM110 Wi-Fi® Module Software Quick-Start Guide*
- *WGM110 API Reference Manual*

13.3 Knowledge Base

Silicon Labs provides an online knowledge base on its web site offering an efficient way of exchanging user experience and enabling the presentation of both questions and solutions to all registered users.

The link to the knowledge base is www.silabs.com/support/knowledgebase.

13.4 Technical Support

If you need further assistance and can not find the answer from the Silicon Labs' Knowledgebase you can contact Silicon Labs Technical Support through a web page.

Technical Support web link: www.silabs.com/support/

14. Revision History

14.1 Revision 1.4

March 31st, 2017

Wi-Fi Direct included.

14.2 Revision 1.3

October 26th, 2016

Soldering recommendation, module tape cover and orientation picture graphics updated.

14.3 Revision 1.2

August 30th, 2016

Added WGM110E variant information.

14.4 Revision 1.1

May 12, 2016

This revision is published with the release of the full production version of the WGM110 Wizard Gecko Wi-Fi™ Module.

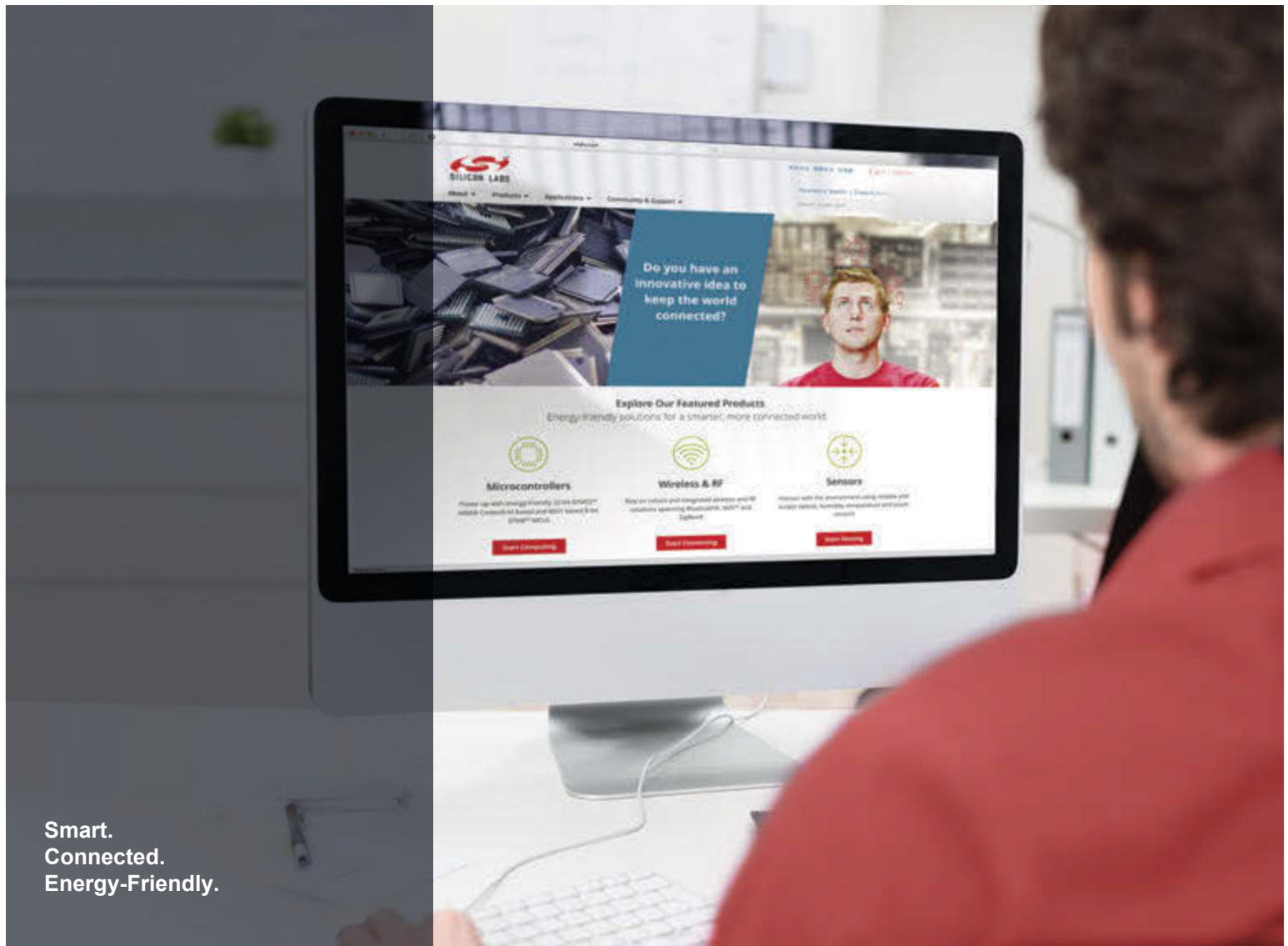
Changes: Added support for IP multicast, power consumption values updated, SPI support information updated, power supply requirements clarified, Ground plane width guideline updated, Japan and Korea certification numbers added.

14.5 Revision 1.0

April 31, 2016

This revision is published with the release of the pre-production version of the WGM110 Wizard Gecko Wi-Fi™ Module.

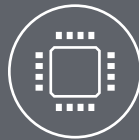
First release.



Smart.
Connected.
Energy-Friendly.



Products
www.silabs.com/products



Quality
www.silabs.com/quality



Support and Community
community.silabs.com

Disclaimer

Silicon Labs intends to provide customers with the latest, accurate, and in-depth documentation of all peripherals and modules available for system and software implementers using or intending to use the Silicon Labs products. Characterization data, available modules and peripherals, memory sizes and memory addresses refer to each specific device, and "Typical" parameters provided can and do vary in different applications. Application examples described herein are for illustrative purposes only. Silicon Labs reserves the right to make changes without further notice and limitation to product information, specifications, and descriptions herein, and does not give warranties as to the accuracy or completeness of the included information. Silicon Labs shall have no liability for the consequences of use of the information supplied herein. This document does not imply or express copyright licenses granted hereunder to design or fabricate any integrated circuits. The products are not designed or authorized to be used within any Life Support System without the specific written consent of Silicon Labs. A "Life Support System" is any product or system intended to support or sustain life and/or health, which, if it fails, can be reasonably expected to result in significant personal injury or death. Silicon Labs products are not designed or authorized for military applications. Silicon Labs products shall under no circumstances be used in weapons of mass destruction including (but not limited to) nuclear, biological or chemical weapons, or missiles capable of delivering such weapons.

Trademark Information

Silicon Laboratories Inc.®, Silicon Laboratories®, Silicon Labs®, SiLabs® and the Silicon Labs logo®, Bluegiga®, Bluegiga Logo®, Clockbuilder®, CMEMS®, DSPLL®, EFM®, EFM32®, EFR, Ember®, Energy Micro, Energy Micro logo and combinations thereof, "the world's most energy friendly microcontrollers", Ember®, EZLink®, EZRadio®, EZRadioPRO®, Gecko®, ISOModem®, Precision32®, ProSLIC®, Simplicity Studio®, SiPHY®, Telegesis, the Telegesis Logo®, USBXpress® and others are trademarks or registered trademarks of Silicon Labs. ARM, CORTEX, Cortex-M3 and THUMB are trademarks or registered trademarks of ARM Holdings. Keil is a registered trademark of ARM Limited. All other products or brand names mentioned herein are trademarks of their respective holders.



Silicon Laboratories Inc.
400 West Cesar Chavez
Austin, TX 78701
USA

<http://www.silabs.com>